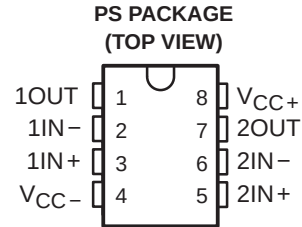


- Wide Range of Supply Voltages; Single Supply . . . 3 V to 36 V, or Dual Supplies
- Class AB Output Stage
- High-Impedance N-Channel-JFET Input Stage . . . $10^{12} \Omega$ Typ
- Internal Frequency Compensation
- Short-Circuit Protection
- Input Common Mode Includes V_{CC-}
- Low Input Offset Current . . . 50 pA
- Low Input Bias Current . . . 200 pA Typ



description

The TL092 JFET-input operational amplifier is similar in performance to the MC3403 family, but with much higher input impedance derived from a FET input stage. The N-channel-JFET input stage allows a common-mode input voltage range that includes the negative supply voltage and offers a typical input impedance of $10^{12} \Omega$, a typical input offset current of 50 pA, and a typical input bias current of 200 pA. This device is designed to operate from a single supply over a range of 3 V to 36 V. Operation from split supplies also is possible, provided the difference between the two supplies is 3 V to 36 V. Output voltage range is from V_{CC-} to $V_{CC+} - 1.3$ V, with a load resistor to V_{CC-} .

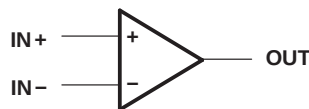
The TL092 is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

T_A	PACKAGED DEVICE
	PLASTIC SMALL OUTLINE (PS)
0°C to 70°C	TL092CPSR

The PS package is only available taped and reeled. Add the suffix R to device type for ordering (e.g., TL092CPSR).

symbol



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS
INSTRUMENTS**

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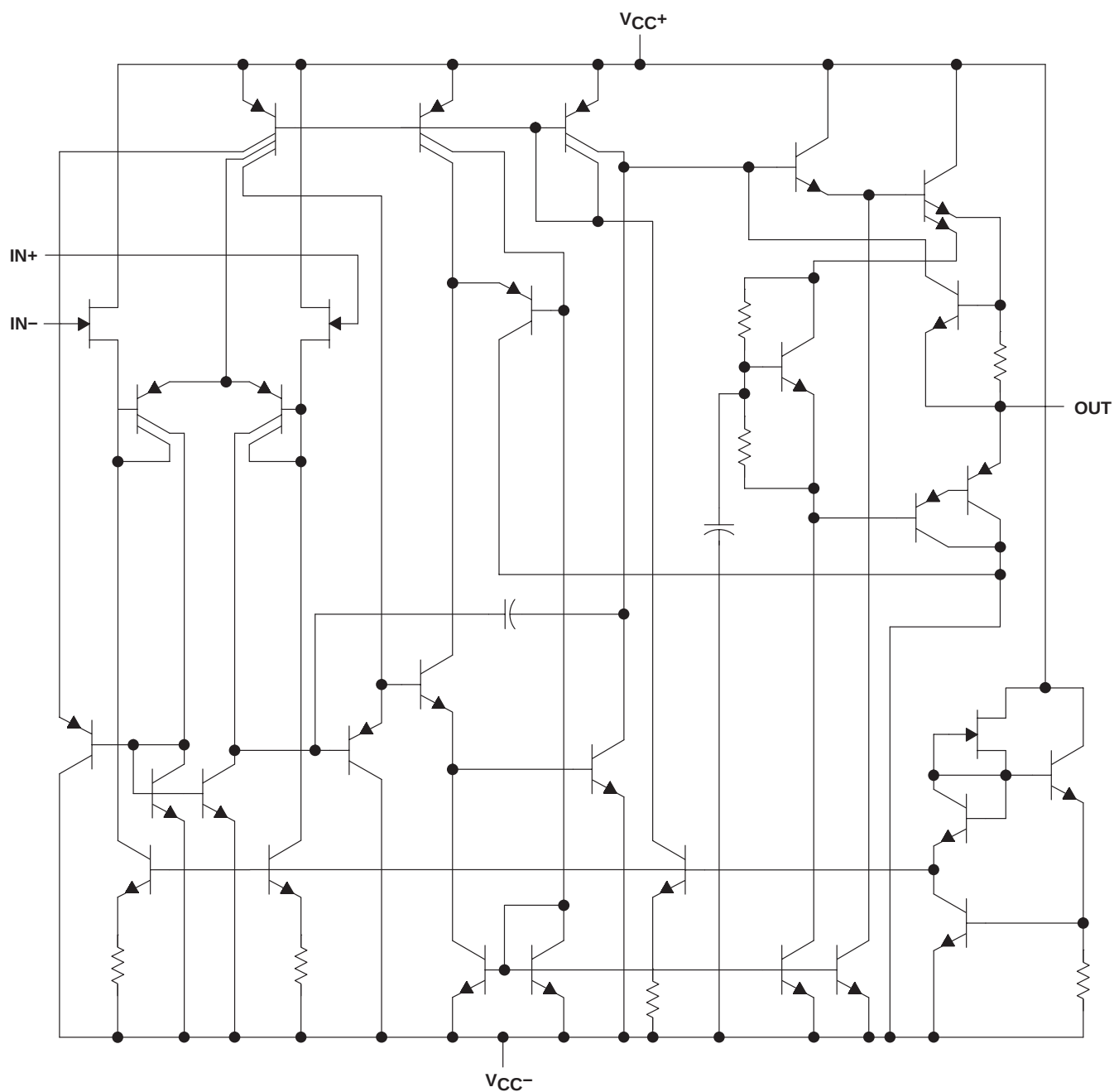
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TL092

DUAL JFET-INPUT OPERATIONAL AMPLIFIER

SLOS372 – JUNE 2001

schematic



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

Supply voltage: V_{CC+} (see Note 1)	18 V
V_{CC-} (see Note 1)	–18 V
V_{CC+} with respect to V_{CC-}	36 V
Differential input voltage, V_{ID} (see Note 2)	±36 V
Input voltage, V_I (see Notes 1 and 3)	±18 V
Package thermal impedance, θ_{JA} (see Notes 4 and 5)	95°C/W
Lead temperature 1.6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, T_{stg}	–65°C to 150°C

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-} .
 2. Differential voltages are at the noninverting input with respect to the inverting input.
 3. Neither input must ever be more positive than V_{CC+} or more negative than $V_{CC-} - 0.3$ V.
 4. Maximum power dissipation is a function of $T_J(\text{max})$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 5. The package thermal impedance is calculated in accordance with JESD 51-7.

recommended operating conditions

	MIN	MAX	UNIT
$V_{CC\pm}$ Supply voltage	3	36	V
T_A Operating free-air temperature range	0	70	°C

TL092

DUAL JFET-INPUT OPERATIONAL AMPLIFIER

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electrical characteristics at specified free-air temperature, $V_{CC\pm} = \pm 15\text{ V}$
(all characteristics are specified under open-loop conditions, unless otherwise noted)

PARAMETER	TEST CONDITIONS	T_A	MIN	TYP [†]	MAX	UNIT
V_{IO} Input offset voltage	$R_S = 50\ \Omega$	25°C		5	15	mV
		Full range			20	
αV_{IO} Temperature coefficient of input offset voltage		25°C		10		$\mu\text{V}/^\circ\text{C}$
$I_{IO}^\ddagger$ Input offset current		25°C		50	200	pA
		Full range			5	nA
$I_{IB}^\ddagger$ Input bias current		25°C		200	400	pA
		Full range			10	nA
V_{ICR} Common-mode input voltage range		25°C	V_{CC-} to 12	V_{CC-} to 13		V
$V_{O(PP)}$ Peak output voltage swing	$R_L = 2\text{ k}\Omega$	25°C	± 10	± 13		V
	$R_L = 10\text{ k}\Omega$	25°C	± 12	± 13.5		
	$R_L = 2\text{ k}\Omega$	Full range	± 10			
A_{VD} Large-signal differential voltage amplification	$R_L = 2\text{ k}\Omega$, $V_O = \pm 10\text{ V}$	25°C	20	200		V/mV
		Full range	15			
B_{OM} Maximum output swing bandwidth	$R_L = 2\text{ k}\Omega$, $V_{O(PP)} = 20\text{ V}$, $A_{VD} = 1$, $\text{THD} < 5\%$	25°C		9		kHz
B_1 Unity gain bandwidth	$R_L = 10\text{ k}\Omega$, $V_O = 50\text{ mV}$	25°C		1		MHz
ϕ_m Phase margin	$R_L = 2\text{ k}\Omega$, $C_L = 200\text{ pF}$	25°C		60°		
r_i Input resistance	$f = 20\text{ Hz}$	25°C		10^{12}		Ω
r_o Output resistance	$f = 20\text{ Hz}$	25°C		75		Ω
CMRR Common-mode rejection ratio	$R_S = 50\ \Omega$, $V_{IC} = V_{ICR}$	25°C	70	90		dB
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)	$R_S = 50\ \Omega$, $V_{CC\pm} = \pm 3\text{ V}$ to $\pm 15\text{ V}$	25°C	75	90		dB
I_{OS} Short-circuit output current		25°C		40		mA
I_{CC} Supply current (per amplifier)	$V_O = 0$, No load	25°C		1.5	2.5	mA

[†] All typical values are at $T_A = 25^\circ\text{C}$.

[‡] Input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive. Pulse techniques that maintain the junction temperature as close to the ambient temperature as possible must be used.

electrical characteristics at specified free-air temperature, $V_{CC+} = 5\text{ V}$, $V_{CC-} = 0\text{ V}$, $T_A = 25^\circ\text{C}$
(unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP [†]	MAX	UNIT
V_{IO} Input offset voltage	$R_S = 50\ \Omega$, $V_O = 2.5\text{ V}$		5	15	mV
I_{IO} Input offset current	$V_O = 2.5\text{ V}$		50	200	pA
I_{IB} Input bias current	$V_O = 2.5\text{ V}$		200	400	pA
$V_{O(PP)}$ Peak output voltage swing	$R_L = 10\text{ k}\Omega$		3.3	3.5	V
	$R_L = 10\text{ k}\Omega$, $V_{CC+} = 5\text{ V}$ to 30 V	$V_{CC+} - 1.7$			V
A_{VD} Large-signal differential voltage amplification	$R_L = 2\text{ k}\Omega$, $\Delta V_O = 1.6\text{ V}$	20	200		V/mV
k_{SVR} Supply-voltage rejection ratio ($\Delta V_{CC}/\Delta V_{IO}$)	$R_S = 50\ \Omega$, $V_{CC\pm} = \pm 3\text{ V}$ to $\pm 15\text{ V}$	75			dB
I_{CC} Supply current (per amplifier)	$V_O = 2.5\text{ V}$, No load		1.5	2.5	mA
V_{O1}/V_{O2} Channel separation	$f = 1\text{ kHz}$ to 20 kHz		120		dB

[†] All typical values are at $T_A = 25^\circ\text{C}$.



operating characteristics, $V_{CC\pm} = \pm 15\text{ V}$, $T_A = 25^\circ\text{C}$

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
SR Slew rate at unity gain	$V_I = \pm 10\text{ V}$ (see Figure 1), $C_L = 100\text{ pF}$, $R_L = 2\text{ k}\Omega$		0.6		$\text{V}/\mu\text{s}$
t_r Rise time	$\Delta V_O = 50\text{ mV}$ (see Figure 1), $C_L = 100\text{ pF}$, $R_L = 2\text{ k}\Omega$		0.2		μs
t_f Fall time	$\Delta V_O = 50\text{ mV}$ (see Figure 1), $C_L = 100\text{ pF}$, $R_L = 2\text{ k}\Omega$		0.2		μs
Overshoot factor	$\Delta V_O = 50\text{ mV}$ (see Figure 1), $C_L = 100\text{ pF}$, $R_L = 2\text{ k}\Omega$		20%		
Crossover distortion	$V_{I\text{PP}} = 30\text{ mV}$, $V_{O(\text{PP})} = 2\text{ V}$, $f = 10\text{ kHz}$		1%		
V_n Equivalent input noise voltage	$R_S = 100\text{ }\Omega$, $f = 1\text{ kHz}$		34		$\text{nV}/\sqrt{\text{Hz}}$

PARAMETER MEASUREMENT INFORMATION

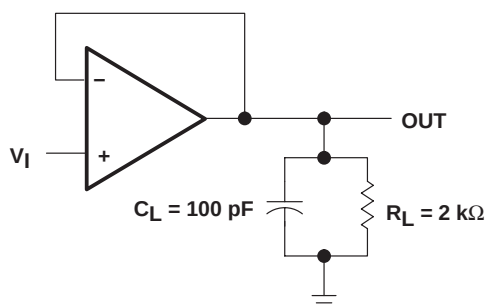


Figure 1. Unity-Gain Amplifier

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
TL092CPSR	Active	Production	SO (PS) 8	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	T092
TL092CPSR.A	Active	Production	SO (PS) 8	2000 LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	T092

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

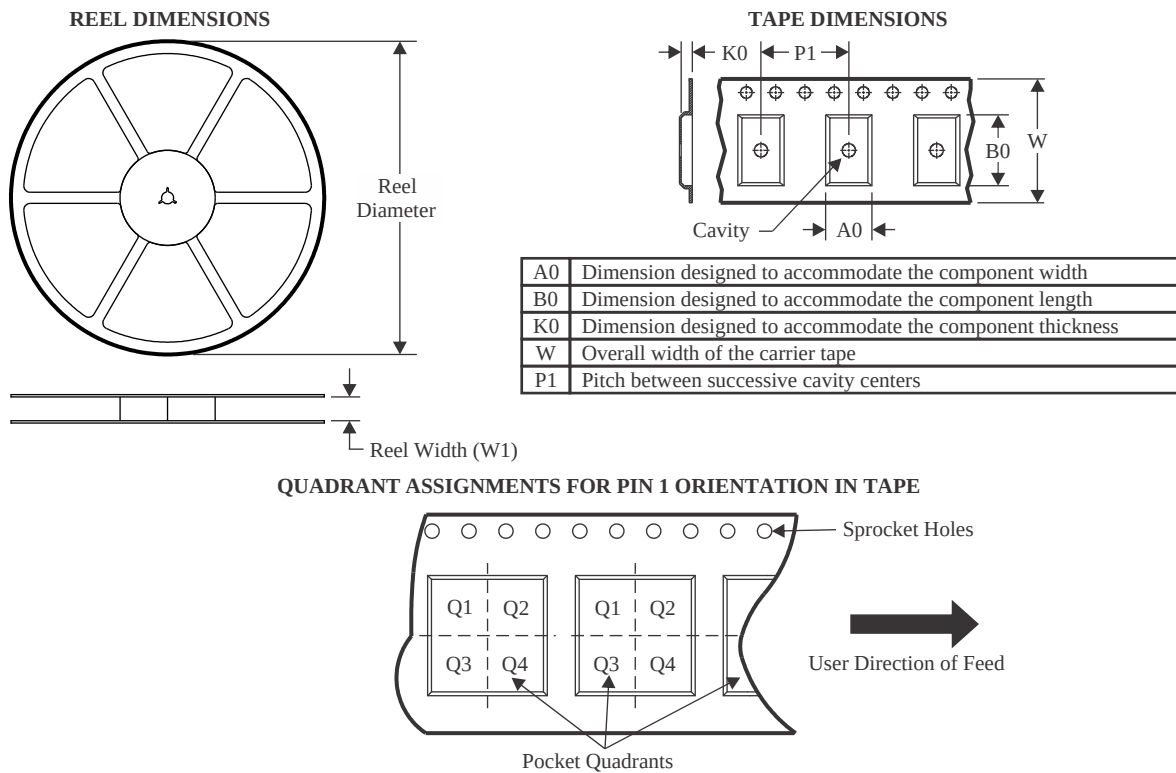
⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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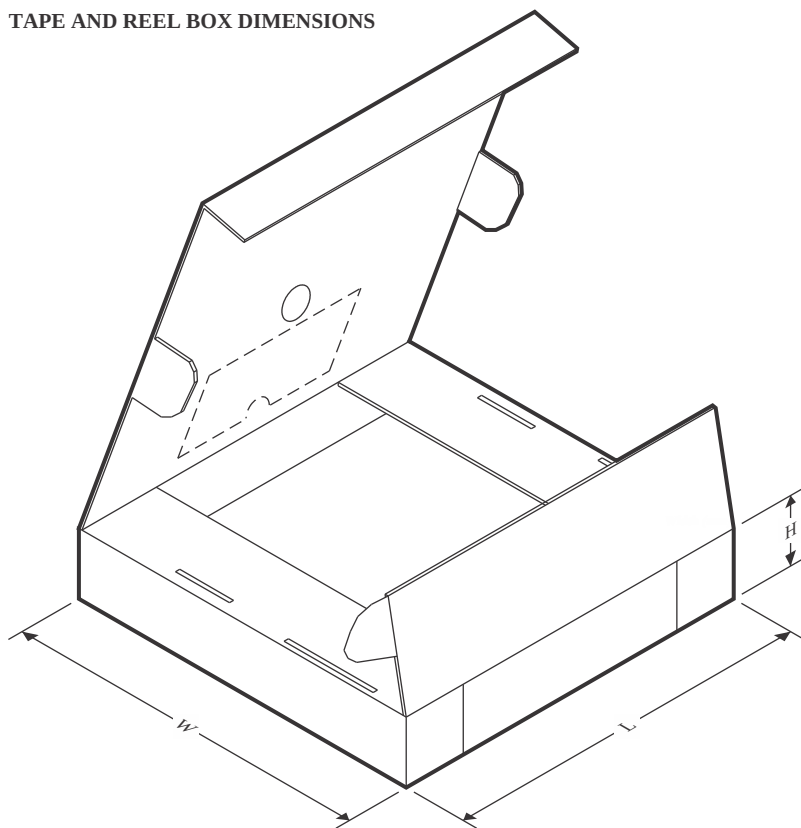
TAPE AND REEL INFORMATION



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL092CPSR	SO	PS	8	2000	330.0	16.4	8.35	6.6	2.4	12.0	16.0	Q1

TAPE AND REEL BOX DIMENSIONS



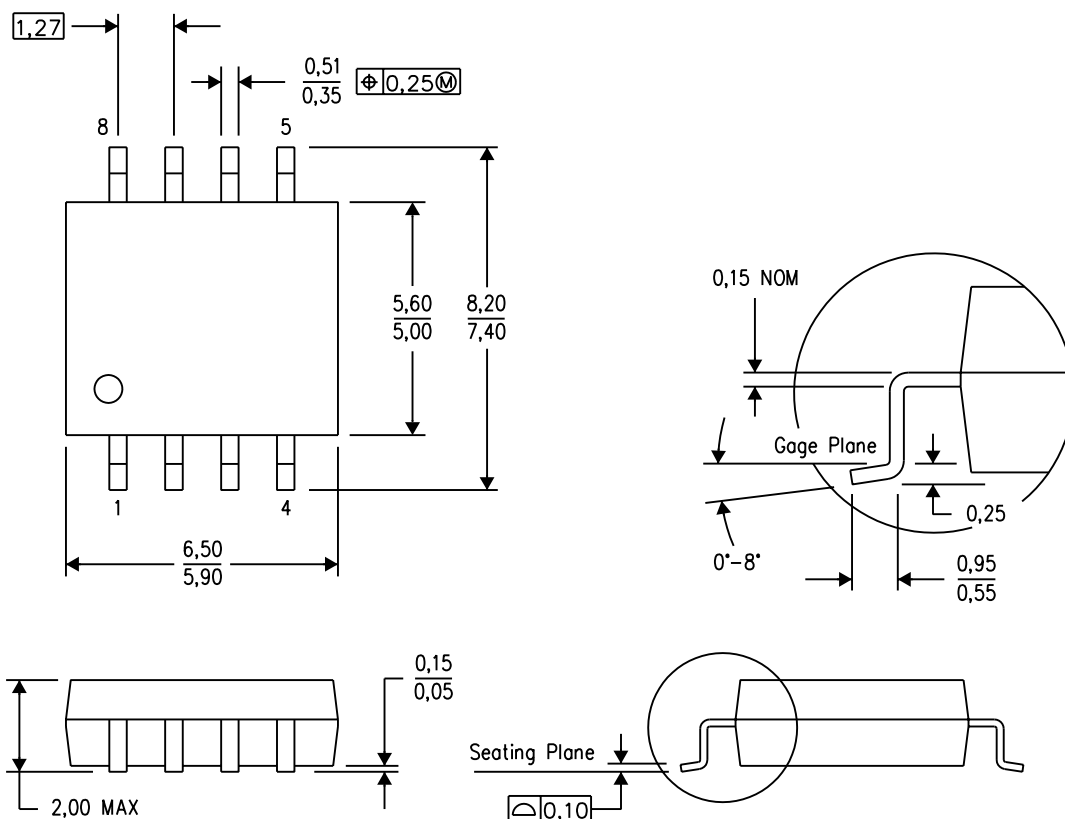
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL092CPSR	SO	PS	8	2000	356.0	356.0	35.0

MECHANICAL DATA

PS (R-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE



4040063/C 03/03

- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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